



Part Number : [430451025](#)

Product Description : Micro-Fit 3.0 Vertical Header, 3.00mm Pitch, Dual Row, 10 Circuits, with PCB Press-fit Metal Retention Clip, 0.38µm Gold Plating, Glow-Wire Capable, Black

Series Number : 43045

Status : Active

Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

[430451025 sd.pdf](#)

[PK-70873-0314-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)

[SYM-43045-1024-001.zip](#)

[SYM-43045-1024 6-001.zip](#)

Specifications

[430450001-AS-000.pdf](#)

[430450001-PS-KO-000.pdf](#)

[430450001-PS-SP-000.pdf](#)

[PS-43045-001.pdf](#)

[430450006-TS-000.pdf](#)

[430450007-TS-000.pdf](#)

[TS-43045-001-001.pdf](#)

[TS-43045-002-001.pdf](#)

[TS-46235-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	43045
Description	Micro-Fit 3.0 Vertical Header, 3.00mm Pitch, Dual Row, 10 Circuits, with PCB Press-fit Metal Retention Clip, 0.38µm Gold Plating, Glow-Wire Capable, Black
Application	Wire-to-Board
Comments	High Temperature, Square Pin, Offset Through Hole Mounting,

	Solder Type; This Molex product is manufactured from material that has the following ratings, tested by independent agencies: a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12 and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options.
Component Type	PCB Header
Product Name	Micro-Fit 3.0
UPC	800753826328

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	8.5A
Voltage - Maximum	600V

Physical

Breakaway	No
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Gender	Male
Glow-Wire Capable	Yes
Mated Height	17.64mm
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Mounting Style	Through Hole
Net Weight	1.552/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.381µm
Plating min - Termination	2.540µm
Polarized to PCB	Yes
Shrouded	Shrouded
Stackable	No
Temperature Range - Operating	-40° to +125°C
Termination Interface Style	Through Hole - Kinked Pin

Solder Process Data

Max-Duration	30
Lead-Free Process Capability	SMC&WAVE

Max-Cycle	3
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Micro-Fit 3.0 Dual Row Receptacle Housings	<u>43025</u>
Micro-Fit TPA Receptacle Housings	<u>172952</u>
Micro-Fit 3.0 Female-to-Micro-Fit 3.0 Female Off-the-Shelf (OTS) Cable Assemblies	<u>214755</u>
Micro-Fit 3.0 Female-to-Pigtail Off-the-Shelf (OTS) Cable Assemblies	<u>214756</u>

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